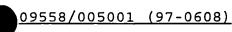


Attorney Docket N

DECLARATION



SOLE/JOINT INVENTOR ORIGINAL/SUBSTITUTE/CIP

As a below named inventor, I hereby declare that my residence, post office address, and citizenship are as stated below next to my name. I believe I am the original, first, and sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

TRENCH ISOLATION FOR	SEMICONDUCTOR DEVICE	.5	
as described in the s Serial No.			
I hereby state that I have reviewed and amendment referred to above; that I do not our invention thereof, or patented or descrito this application; that the invention has not any country foreign to the United States of to this application; and that I acknowledge in accordance with Title 37, Code of Federa or being made of record in the application,	ot know and do not believe the same waibed in any printed publication in any color been patented or made the subject of America on an application filed by me the duty to disclose information of which Regulations § 1.56(a). Such information	as ever known or used in the Lountry before my or our invention of an inventor's certificate issued or my legal representative or a shift am aware which is material	Inited States of America before my or in thereof or more than one year prior d before the date of this application in ssigns more than twelve months prior to the examination of this application
(2) it refutes, or is incons (i)	If or in combination with other informati istent with, a position the applicant hat opposing an argument of unpatentability asserting an argument of patentability.	s taken or may take in: ty relied on by the Office, or	atentability of a claim; or
I hereby claim foreign priority benefits undebelow and have also identified below any			
E: COUNTRY	APPLICATION NUMBER	DATE OF FILING	PRIORITY CLAIMED UNDER 35 USC 119
			☐ YES ☐ NO
Hereby declare that all statements made he true; and further that these statements imprisonment, or both, under Section 1001 application or any patent issued thereon.	were made with the knowledge that will	ful false statements and the lik	e so made are punishable by fine or
FULL NAME OF SOLE OR FIRST INVENTOR	INVENTOR'S SIGNATURE	ра	TE ,
John T. Moore	De I M	100	2/6/97
RESIDENCE		Cit	IZENSHIP
12530 W. Lexus Ct. Boise, Idaho 83713 POST OFFICE ADDRESS		US	A.
12530 W. Lexus Ct. Boise, Idaho 83713			
FULL NAME OF SECOND JOINT INVENTOR	INVENTOR'S SIGNATURE	DA	TE
David L. Chapek RESIDENCE		CIT	IZENSHIP
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Mail Stop 71 7 Continental Blvd. 4 Cerimack, NH 03054		•	



Attorney Docket **DECLARATION**



09558/005001 (97-0608)

SOLE/JOINT INVENTOR ORIGINAL/SUBSTITUTE/CIP

As a below named inventor, I hereby declare that: my residence, post office address, and citizenship are as stated below next to my name. I believe I am the original, first, and sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

TRENCH ISOLATION FOR	SEMICONDUCTOR DEVICE	<u>'S</u>	
as described in the s			
I hereby state that I have reviewed and amendment referred to above; that I do nour invention thereof, or patented or describe to this application; that the invention has any country foreign to the United States of this application; and that I acknowledge in accordance with Title 37, Code of Federal or being made of record in the application	ot know and do not believe the same wanted in any printed publication in any control been patented or made the subject of America on an application filed by mented the duty to disclose information of whical Regulations § 1.56(a). Such information	as ever known or used in the lountry before my or our invention fan inventor's certificate issue or my legal representative or a h I am aware which is material	United States of America before my on thereof or more than one year prior d before the date of this application in assigns more than twelve months prior to the examination of this application
(2) it refutes, or is incon: (i)	elf or in combination with other informations sistent with, a position the applicant has opposing an argument of unpatentabilions asserting an argument of patentability.	s taken or may take in:	atentability of a claim; or
I hereby claim foreign priority benefits und below and have also identified below any			
COUNTRY	APPLICATION NUMBER	DATE OF FILING	PRIORITY CLAIMED UNDER 35 USC 119
			☐ YES ☐ NO
Thereby claim the benefit under Title 35 Left any claim of this application is not disclo	sed in the prior United States Application	. I acknowledge the duty to dis	sclose material information as defined
in Title 37 Code of Federal Regulations &			
date of this application:			
==: ====			
hereby declare that all statements made be true; and further that these statements	herein of my own knowledge are true and were made with the knowledge that will	d that all statements made on ful false statements and the lil	information and belief are believed to ke so made are punishable by fine or
imprisonment, or both, under Section 1001	of Title 18 of the United States Code an	d that such willful false stateme	ents may jeopardize the validity of the
application or any patent issued thereon.			
FULL NAME OF SOLE OR FIRST INVENTOR	INVENTOR'S SIGNATURE	DA	ALE.
John T. Moore			
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Boise, Idaho 83713			
POST OFFICE ADDRESS	-		
12530 W. Lexus Ct.			
Boise, Idaho 83713 FULL NAME OF SECOND JOINT INVENTOR	INVENTOR'S SIGNATURE	7 .7 / 107	NTE ,
David L. Chapek	16/21-16		12/12/97
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